



# Product Change Notification

## 108775 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 108775 - 00  
**Change Title:** Intel(R) Carrier Grade Server TIGH2U, PCN 108775-00, Product Design, Fab Spin to Improve CPU FSB Routing  
**Date of Publication:** August 27, 2008

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Nov 26, 2008
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## Description of Change to the Customer:

Intel is implementing a printed circuit board (PCB) change to improve the Front Side Bus (FSB) routing for the secondary processor. This design change will result in better signal quality.

## Customer Impact of Change and Recommended Action:

No customer impact is being projected.

## Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Post Change TA
TLHA0201W	890868	E17592-XXX	E17592-YYY
TLHD0201W	890910	E17593-XXX	E17593-YYY
NSCSASBSDW	889828	D78511-XXX	D78511-YYY

## PCN Revision History:

<b>Date of Revision:</b> August 27, 2008	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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